STI6N90K5



N-channel 900 V, 0.91 Ω typ., 6 A MDmesh™ K5 Power MOSFET in an I²PAK package

Datasheet - production data

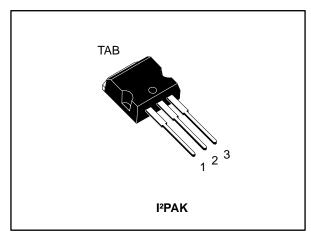
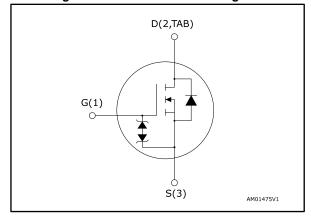


Figure 1: Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max.	I _D	
STI6N90K5	900 V	1.10 Ω	6 A	

- Industry's lowest R_{DS(on)} x area
- Industry's best FoM (figure of merit)
- Ultra-low gate charge
- 100% avalanche tested
- Zener-protected

Applications

• Switching applications

Description

This very high voltage N-channel Power MOSFET is designed using MDmesh™ K5 technology based on an innovative proprietary vertical structure. The result is a dramatic reduction in on-resistance and ultra-low gate charge for applications requiring superior power density and high efficiency.

Table 1: Device summary

Order code	Marking	Package	Packing
STI6N90K5	6N90K5	I²PAK	Tube

Contents STI6N90K5

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STI6N90K5 Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _G s	Gate-source voltage	± 30	V
I _D	Drain current (continuous) at T _C = 25 °C	6	Α
ΙD	Drain current (continuous) at T _C = 100 °C	4	Α
I _D ⁽¹⁾	Drain current (pulsed) 24		Α
P _{TOT}	Total dissipation at T _C = 25 °C	110 W	
dv/dt (2)	Peak diode recovery voltage slope	4.5	\//n a
dv/dt (3)	MOSFET dv/dt ruggedness	50	V/ns
Tj	Operating junction temperature range	FF 45 450	
T _{stg}	Storage temperature range	- 55 to 150	°C

Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case	1.14	°C/W
R _{thj-amb}	Thermal resistance junction-ambient	62.5	°C/W

Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR}	Avalanche current, repetitive or not repetitive (pulse width limited by T _{jmax})	2	А
Eas	Single pulse avalanche energy (starting T_j = 25 °C, I_D = I_{AR} , V_{DD} = 50 V)	210	mJ

⁽¹⁾Pulse width limited by safe operating area

 $^{^{(2)}}I_{SD} \le 6$ A, di/dt ≤ 100 A/µs; VDs peak < V(BR)DSS, VDD = 450 V.

 $^{^{(3)}}V_{DS} \le 720 \text{ V}$

Electrical characteristics STI6N90K5

2 Electrical characteristics

T_C = 25 °C unless otherwise specified

Table 5: On/off-state

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$	900			V
		$V_{GS} = 0 \text{ V}, V_{DS} = 900 \text{ V}$			1	μΑ
I _{DSS}	Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 900 \text{ V}$ $T_{C} = 125 \text{ °C}^{(1)}$			50	μΑ
Igss	Gate body leakage current	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			±10	μΑ
V _{GS(th)}	Gate threshold voltage	$V_{DD} = V_{GS}$, $I_D = 100 \mu A$	3	4	5	V
R _{DS(on)}	Static drain-source on- resistance	V _G S = 10 V, I _D = 3 A		0.91	1.10	Ω

Notes:

Table 6: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	342	-	pF
Coss	Output capacitance	$V_{DS} = 100 \text{ V}, f = 1 \text{ MHz},$ $V_{GS} = 0 \text{ V}$	ı	31	-	pF
C_{rss}	Reverse transfer capacitance	V 65 – V V	-	1.2	-	pF
C _{o(tr)} (1)	Equivalent capacitance time related	V _{DS} = 0 to 720 V,	-	55	-	pF
C _{o(er)} ⁽²⁾	Equivalent capacitance energy related	$V_{GS} = 0 V$	ı	20	-	pF
Rg	Intrinsic gate resistance	f = 1 MHz, I _D = 0 A	ı	6.4	-	Ω
Q_g	Total gate charge	$V_{DD} = 720 \text{ V}, I_D = 6 \text{ A}$	-	11	-	nC
Qgs	Gate-source charge	V _{GS} = 10 V	-	2.5	-	nC
Q _{gd}	Gate-drain charge	(see Figure 15: "Test circuit for gate charge behavior")	-	7	-	nC

Notes:

⁽¹⁾ Defined by design, not subject to production test.

 $^{^{(1)}}$ $C_{O(tr)}$ is a constant capacitance value that gives the same charging time as C_{OSS} while V_{DS} is rising from 0 to 80% V_{DSS}

 $^{^{(2)}}$ $C_{\text{O(er)}}$ is a constant capacitance value that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 80% $V_{\text{DSS}}.$

Table 7: Switching times

Table 11 differences							
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
t _{d(on)}	Turn-on delay time	V_{DD} = 450 V, I_{D} = 3 A, R_{G} = 4.7 Ω	ı	12.4	1	ns	
tr	Rise time	V _{GS} = 10 V	ı	12.2	1	ns	
t _{d(off)}	Turn-off delay time	(see Figure 14: "Test circuit for resistive load switching times" and	-	30.4	-	ns	
t _f	Fall time	Figure 19: "Switching time waveform")	-	15.5	-	ns	

Table 8: Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-		6	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		24	Α
V _{SD} ⁽²⁾	Forward on voltage	I _{SD} = 6 A, V _{GS} = 0 V	-		1.5	V
t _{rr}	Reverse recovery time	I _{SD} = 6 A, di/dt = 100 A/μs, V _{DD} = 60 V (see Figure 16: "Test circuit for inductive load switching and diode recovery times")	-	342		ns
Qrr	Reverrse recovery charge		-	3.13		μC
I _{RRM}	Reverse recovery current		-	18.3		Α
t _{rr}	Reverse recovery time	I _{SD} = 6 A, di/dt = 100 A/µs,	-	536		ns
Qrr	Reverse recovery charge	V _{DD} = 60 V, T _i = 150 °C (see Figure 16: "Test circuit for inductive load switching and diode recovery times")	-	4.42		μC
I _{RRM}	Reverse recovery current		-	16.5		А

Notes:

Table 9: Gate-source Zener diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)GSO}$	Gate-source breakdown voltage	$I_{GS} = \pm 1 \text{ mA}, I_D = 0 \text{ A}$	30	-		V

The built-in back-to-back Zener diodes are specifically designed to enhance the ESD performance of the device. The Zener voltage facilitates efficient and cost-effective device integrity protection, thus eliminating the need for additional external componentry.



⁽¹⁾Pulse width limited by safe operating area

 $^{^{(2)}}$ Pulsed: pulse duration = 300 μ s, duty cycle 1.5%

2.1 Electrical characteristics (curves)

Figure 2: Safe operating area GIPG311020160947SOA (A) Operation in this area is limited by R_{DS(on)} 10 t_o=10 μs t_o=100 μs 10⁰ t_p=1 ms t_p=10 ms V_{cs}= 10 V T_j≤150 °C 10 $T_c = 25^{\circ}C$ single pulse 10⁻² $\overline{V}_{DS}(V)$ 10¹ 10²

Figure 3: Thermal impedance

CG20930 $\delta = 0.5$ $\delta = 0.2$ $\delta = 0.1$ $\delta = 0.1$ $\delta = 0.01$ $\delta = 0$

Figure 4: Output characteristics

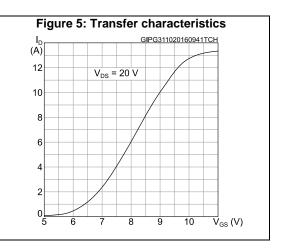
ID GIPG311020160942OCH
(A) VGS=10, 11 V

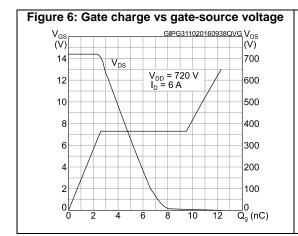
12 VGS=9 V

10 VGS=8 V

2 VGS=6 V

0 4 8 12 16 VGS (V)





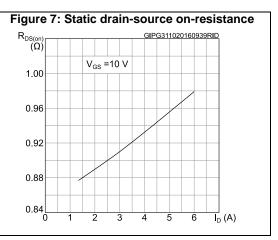


Figure 8: Capacitance variations

C GIPG311020160937CVR

10³

10²

Coss

C

Figure 10: Normalized on-resistance vs temperature

R_{DS(on)} GIPG311020160944RON

2.6 V_{GS} = 10 V

2.2

1.8

1.4

1.0

0.6

0.2

-75

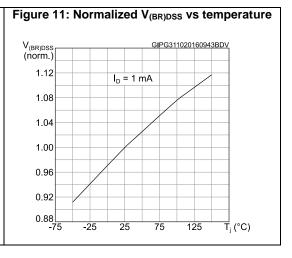
-25

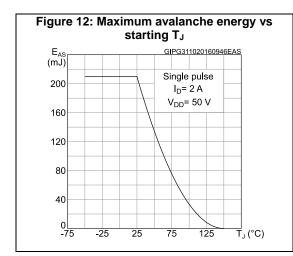
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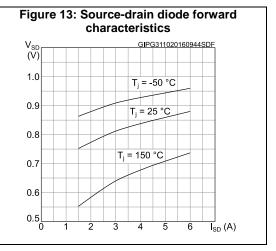
75

125

T_j (°C)







Test circuits STI6N90K5

3 Test circuits

Figure 14: Test circuit for resistive load switching times

Figure 15: Test circuit for gate charge behavior

Figure 15: Test circuit for gate charge behavior

OVDD

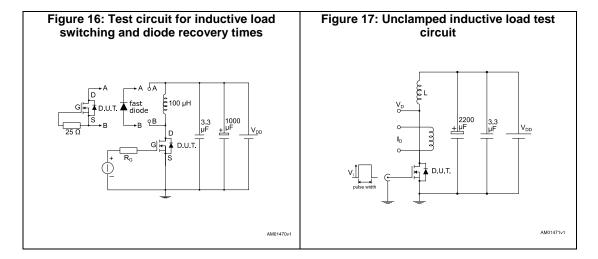
RL

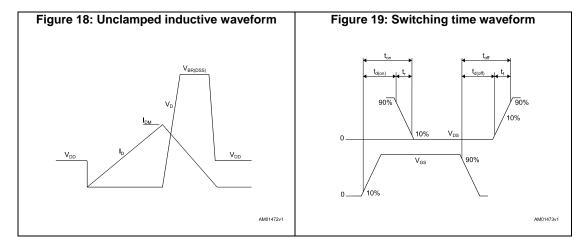
Vos

pulse width

AM01468v1

AM01468v1





STI6N90K5 Package information

4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

4.1 I²PAK package information

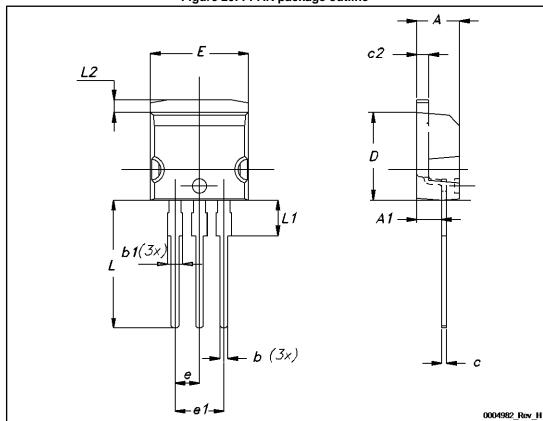


Figure 20: I²PAK package outline

Table 10: I²PAK package mechanical data

Di	mm			
Dim.	Min.	Тур.	Max.	
A	4.40	_	4.60	
A1	2.40	_	2.72	
b	0.61	_	0.88	
b1	1.14	_	1.70	
С	0.49	_	0.70	
c2	1.23	_	1.32	
D	8.95	_	9.35	
е	2.40	_	2.70	
e1	4.95	_	5.15	
Е	10	_	10.40	
L	13	_	14	
L1	3.50	_	3.93	
L2	1.27	_	1.40	

STI6N90K5 Revision history

5 Revision history

Table 11: Document revision history

Date	Revision	Changes
02-Nov-2016	1	First release.

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